# RSX-8

# rakon

#### **SMD Communication Crystals**

Low profile SMD AT-cut quartz crystal in a ceramic package with a 3.2mm  $\times$  2.5mm footprint.

Description

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#### **Product description**

Miniature low profile AT-cut quartz crystal. True SMD style, ceramic package with metal lid, seam sealed. The product is supplied on tape and reel.

#### **Applications**

- Feature phone
- GPS

#### **Features**

**1.0** Line

• Excellent shock and vibration performance

SPECIFICATION REFERENCES

- · Low aging
- Very good short term stability

Parameter

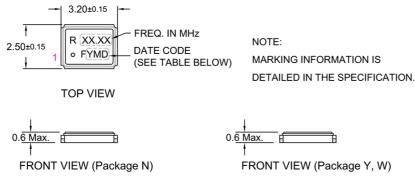
#### **Specifications**

LITTE	rararrecei	Description		
1.1	Model description	RSX-8		
1.2	RoHS compliant	Yes		
1.3	Reference number			
1.4	Rakon part number			
1.5	Package	Package N, Y, W, M and AB		
2.0	FREQUENCY CHARACTER	ISTICS		
Line	Parameter	Test Condition	Value	Unit
2.1	Frequency		16 to 40	MHz
2.2	Calibration tolerance	Frequency at 25°C ±2°C and specified load capacitance	±10 to 50	ppm
2.3	Reflow shift	Two consecutive reflow as per attached profile after 4 hours recovery at $25^{\circ}\text{C}$	±1 max	ppm
2.4	Frequency stability over temperature	Referenced to frequency reading at 25°C and the specified load capacitance	±10 to 50	ppm
2.5	Temperature range	Operating temperature	-55 to 105	°C
2.6	Frequency perturbations	Residual errors from the frequency versus temperature curve fitting 5th order. Minimum of 1 frequency reading every 3°C over operating temperature range	0.1 to 1	ppm
2.7	Static temperature hysteresis	Frequency change after reciprocal temperature ramped over the operating range. Frequency measured before and after at 25°C	±0.4 max	ppm
2.8	Long term stability	Frequency drift over 1 year at 25°C	±1 max	ppm
2.9	g Sensitivity	Gamma vector of all three axes from 30Hz to 1500Hz	2 max	ppb/g
3.0	ELECTRICAL			
Line	Parameter	Test Condition	Value	Unit
3.1	Load capacitance (CL)	Frequency is calibrated at room temperature	5 to 50	pF
3.2	Shunt capacitance (C0)	Operating specification	0.5 to 3	pF
3.3	Pullability	Load and crystal design dependant	0.5 min	ppm/pF
3.4	Drive level	Operating specification	50 max	μW
3.5	Equivalent series resistance (ESR)		60 max	Ω
3.6	Insulation Resistance	100V ±15V at 25°C	500 min	ΜΩ

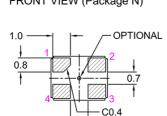
4.0	ENVIRONMENTAL	
Line	Parameter	Description
4.1	Shock	Half sine-wave acceleration of 100g peak amplitude for 11 ms duration, 3 cycles in each plane
4.2	Humidity	After 48 hours at 85°C 85% relative humidity non-condensing
4.3	Thermal shock	Exposed at -40°C for 30 minutes then to 85°C for 30 minutes constantly for a period of 5 days
4.4	Vibration	10g RMS 30 Hz to 1500 Hz duration for 6 hours
4.5	Storage temperature	-55 to 105°C
	, , , , , , , , , , , , , , , , , , ,	
5.0	ENVIRONMENTAL	
Line	Parameter	Description
5.1	Shock	2 cycle drop it onto concrete for six directions (x, y, z) and one corner. The height is 152 cm. Dummy is 120g weight.
5.2	Moisture Resistance	Temperature: 40°C ±2°C; Humidity : 90 $\sim$ 95%; Time : for 240 hours; According to IEC 1178-1.4.8.15
5.3	Thermal Shock	100 temperature cycles, where each cycle consists of a 25 minute soak time at -40°C followed by a 25 minute soak time at 85°C, with a 60 second maximum transition time between temperatures. Air to air transition. According to IEC 1178-1.4.8.4
5.4	Vibration	Frequency: $10 \sim 55$ Hz; Amplitude: $1.5$ mm; Period: $1$ min; Test time: X,Y,Z each direction 2h; According to IEC 1178-1.4.8.7
5.5	Storage temperature	-40 to 85°C
6.0	MANUFACTURING INFOR	
Line	Parameter	Description
6.1	Reflow	Able to withstand solder reflow process
6.2	Packaging description	Tape and Reel. Standard packing quantity is 3000 units per reel
7.0	MARKING	
Line	Parameter	Description
7.1	Type	Laser engraved
7.2	Line 1	[R], $[XX.XX]^*$ = Frequency in MHz (e.g.: 8.000 = 8MHz, 19.20 = 19.2MHz, 100.0 = 100MHz)
7.3	Line 2	[o] = Pin 1, [F] = Factory code, [YMD] = Date code
7.4	* Frequency code	Frequency marking is only represented by the first four significant digits. For example, on a RSX-8 at 16.368MHz, its frequency marking will be 16.36MHz

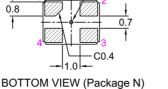
# Drawing Name: RSX-8 Model Drawing (Package N, Y, W & M)

#### MODEL OUTLINE

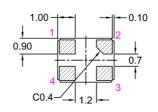






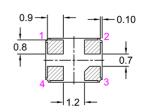


FRONT VIEW (Package Y, W)



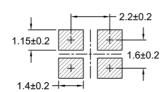
BOTTOM VIEW (Package Y, W)

0.70±0.1 FRONT VIEW (Package M)



BOTTOM VIEW (Package M)

#### RECOMMENDED PAD LAYOUT



TOP VIEW (Package N, Y, W & M)

Y - Year Code

Code	Year	Code	Year
Α	2010	N	2023
В	2011	0	2024
С	2012	Р	2025
D	2013	Q	2026
E	2014	R	2027
F	2015	S	2028
G	2016	T	2029
H	2017	U	2030
1	2018	V	2031
J	2019	W	2032
K	2020	X	2033
L	2021	Υ	2034
M	2022	Z	2035

M - Month Code

Code	Month
1	Jan
2	Feb
3	Mar
4	Apr
5	May
6	Jun
7	Jul
8	Aug
9	Sep
A	Oct
В	Nov
С	Dec

D - Day Code

Code	Day	Code	Day	Code	Day
1	1	Е	14	R	27
2	2	F	15	S	28
3	3	G	16	T	29
4	4	H	17	U	30
5	5	1	18	V	31
6	6	J	19		
7	7	K	20		
8	8	L	21		
9	9	M	22		
Α	10	N	23		
В	11	0	24		
С	12	P	25		
D	13	Q	26		

TITLE: RSX-8 MODEL (Package N, Y, W & M)

**RELATED DRAWINGS:** 

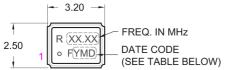
FILENAME: CAT257 REVISION: Н 05-Jun-13 DATE: SCALE: 5:1 Millimetres

TOLERANCES:  $= \pm 0.2$  $= \pm 0.10$ Hole



# Drawing Name: RSX3225S Model Drawing (Package AB & AC)

# MODEL OUTLINE



TOP VIEW (Package AB)





2.5

FRONT VIEW (Package AC)

3.2 -

R(XX.X)

• FYMD

TOP VIEW (Package AC)

FREQ. IN MHz

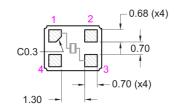
(SEE TABLE BELOW)

DATE CODE

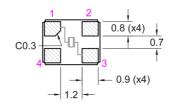




FRONT VIEW (Package AB)



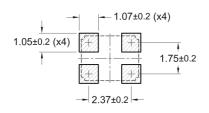
**BOTTOM VIEW (Package AB)** 



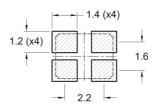
BOTTOM VIEW (Package AC)

PIN	CONNECTIONS
1	CRYSTAL
2	GND
3	CRYSTAL
4	GND

#### RECOMMENDED PAD LAYOUT - TOP VIEW



(Package AB)



(Package AC)

Y - Year Code

Code	Year	Code	Year
Α	2010	N	2023
В	2011	0	2024
С	2012	P	2025
D	2013	Q	2026
E	2014	R	2027
F	2015	S	2028
G	2016	T	2029
н	2017	U	2030
1	2018	V	2031
J	2019	W	2032
K	2020	X	2033
L	2021	Υ	2034
M	2022	Z	2035

M - Month Code

Code	Month
1	Jan
2	Feb
3	Mar
4	Apr
5	May
6	Jun
7	Jul
8	Aug
9	Sep
Α	Oct
В	Nov
С	Dec

D - Day Code

Code	Day	Code	Day	Code	Day
1	1	Е	14	R	27
2	2	F	15	S	28
3	3	G	16	T	29
4	4	H	17	U	30
5	5	1	18	V	31
6	6	J	19		
7	7	K	20		
8	8	L	21		
9	9	M	22		
Α	10	N	23		
В	11	0	24		
С	12	Р	25		
D	13	Q	26		

TITLE: RSX-8 & RSX3225S MODELS (Package AB & AC)

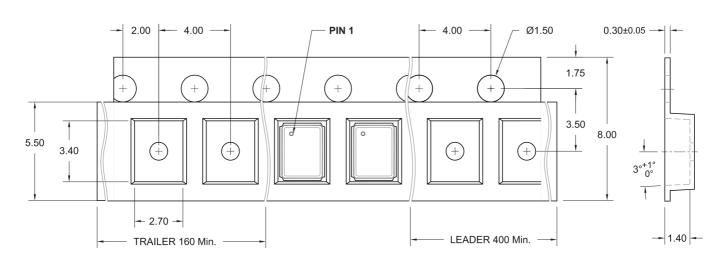
**RELATED DRAWINGS:** 

FILENAME:	CAT803		ANCES
REVISION:	В	XX X.X	$=$ $\pm 0.2$
DATE:	05-Sep-13	X.XX	$= \pm 0.10$
SCALE:	5:1	X.XXX X°	=
Millimetres		Hole	=



# Drawing Name: RSX3225S Tape & Reel (Package AC)

# TAPE DETAIL (Scale 5:1)

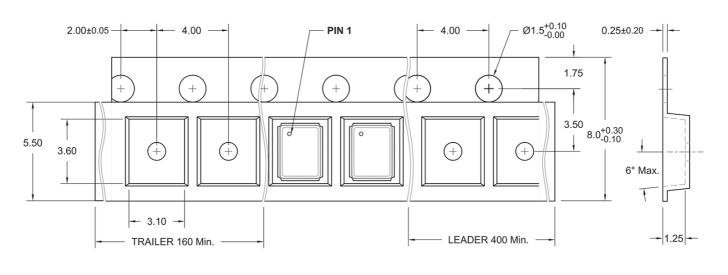


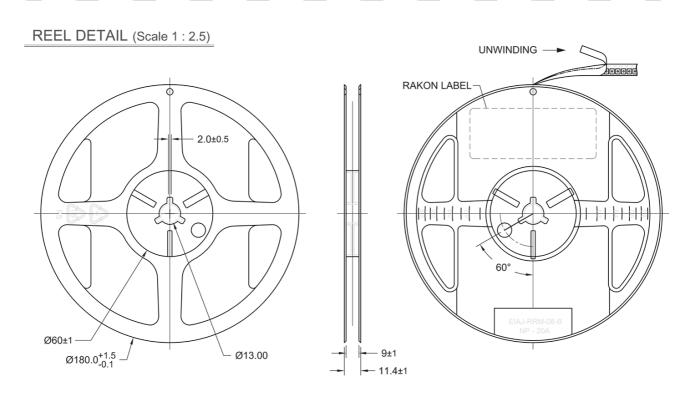
# REEL DETAIL (Scale 1 : 2.5) UNWINDING RAKON LABEL 013.4<sup>+1.0</sup> 013.4<sup>+1.0</sup> 09.5±1

TITLE: RSX3225S TAPE & REEL (Package AC)	FILENAME: CAT827	TOLERANCES: XX =	
RELATED DRAWINGS:	REVISION: A	XX = X.X = ±0.2	
	DATE: 05-Sep-13		rakon
	SCALE: 5:1	X.XXX = X° =	
	Millimetres	Hole =	© 2013 Rakon Limited

# Drawing Name: RSX-8 Tape & Reel (package N, E & W)

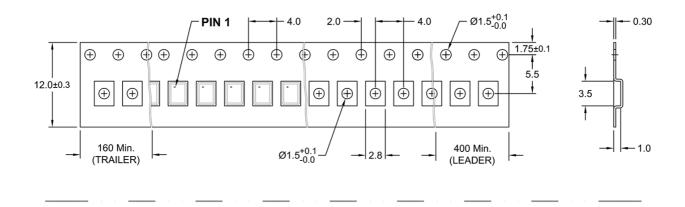
# TAPE DETAIL (Scale 5:1)



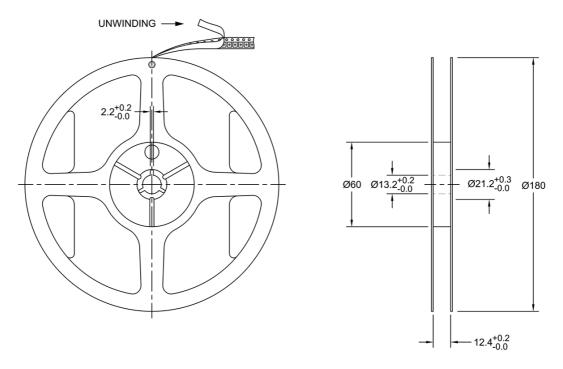


# Drawing Name: RSX-8 Tape & Reel (Package M)

# TAPE DETAIL (SCALE 2 : 1)



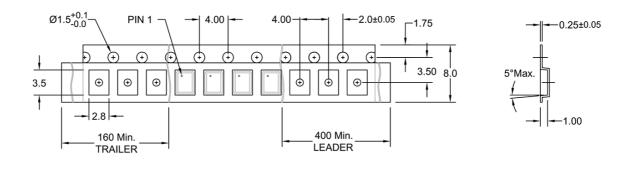
# REEL DETAIL (SCALE 1 : 2.5)



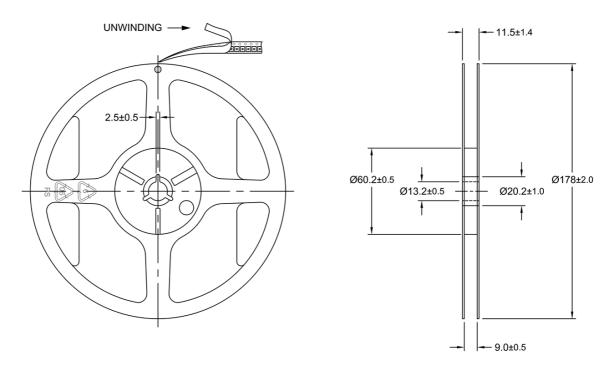
TITLE: RSX-8 TAPE & REEL (Package M)	FILENAME: CAT801	TOLERANCES:	
RELATED DRAWINGS:	REVISION: A	XX = X.X = ±0.1	
	DATE: 12-Jun-13	$X.XX = \pm 0.05$	On
	SCALE: 2:1	X.XXX = X° =	
	Millimetres	Hole = © 2013	Rakon Limited

# Drawing Name: RSX-8 tape & Reel (Package AB)

# TAPE DETAIL (SCALE 2 : 1)



# REEL DETAIL (SCALE 1 : 2.5)



TITLE: RSX-8 3225 TAPE & REEL (Package AB)

FILENAME: CAT804

REVISION: A

DATE: 19-Jun-13

SCALE: 2:1

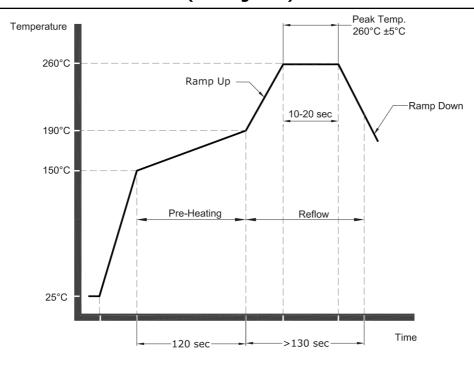
Millimetres

TOLERANCES: XX = ±0.2

X.XX = ±0.10

X.

# Drawing Name: Pb-Free Reflow (Package AC)



#### NOTE:

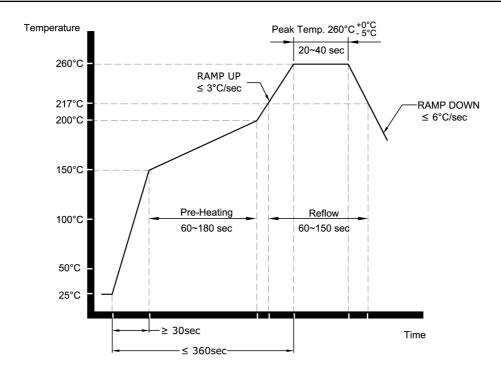
The product has been tested to withstand the Reflow Profile shown. The Reflow Profile used to solder Rakon products is determined by the solder paste Manufacturer's specification. It is recommended that the Reflow Profile used does not exceed the one shown above.

TITLE: Pb-FREE REFLOW (Package AC)	FILENAME: CAT828
RELATED DRAWINGS:	REVISION: A
	DATE: 05-Sep-13
	SCALE: NTS

Millimetres

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# Drawing Name: Pb-Free Reflow



#### NOTE:

The product has been tested to withstand the Reflow Profile shown. The Reflow Profile used to solder Rakon products is determined by the solder paste Manufacturer's specification. It is recommended that the Reflow Profile used does not exceed the one shown above.

TITLE: Pb-FREE REFLOW	FILENAME: CAT541	_
RELATED DRAWINGS:	REVISION: B	
	DATE: 05-Sep-11	: rakon
	SCALE: NTS	
	Millimetres	© 2009 Rakon Limited